L Number	Hits	Search Text	DB	Time stamp
-	821	216/27	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 16:25
-	1205	29/890.1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 16:23
-	374	438/21	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 16:23
-	1747	347/20	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 16:28
-	1974	347/40	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 16:28
-	1086	347/44	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 16:29
-	2459	347/47	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 16:29
-	1448	347/54	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 16:29
-	1639	347/55	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 16:29
-	1866	347/56	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 16:29
-	1871	347/65	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 16:29
-	2488	347/68	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 16:29
-	1177	347/71	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 16:29
-	806	216/17	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 16:30

—	521	216/39	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 16:30
—	1558	216/41	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 16:30
—	205	216/46	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 16:31
—	1521	438/700	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 16:31
—	795	438/705	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 16:32
—	546	438/740	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 16:34
—	4243	(etch$3 and silicon and (impurit$3 or dop$3 or implant$3 or ion$1) and (through-hole or opening or hole or passage$3 or slot)).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 16:58
—	1006	(etch$3 and silicon and (impurit$3 or ion$1) and implant$3 and (through-hole or opening or hole or passage$3 or slot)).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 16:40
—	68	(216/27 or 438/21 or 438/21 or 347/20 orl 347/40 or 347/44 or 347/47 or 347/54 or 347/55 or 347/56 or 347/65 or 347/68 or 347/71) and (etch$3 and silicon and (impurit$3 or dop$3 or implant$3 or ion$1) and (through-hole or opening or hole or passage$3 or slot)).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 16:42
—	133	(etch$3 and silicon and (implant$3 near3 ions) and (through-hole or opening or hole or passage$3 or slot) and (arsenic or boron or phosphorus or antimony)).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 16:52
—	436	(etch$3 and silicon and (implant$3 near3 ions) and (through-hole or opening or hole or passage$3 or slot)).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 16:57
—	110	(etch$3 and silicon and (implant$3 near3 ions) and (through-hole or hole or passage$3 or slot)).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 16:57
—	51	((ink$1jet or printhead) and etch$3 and silicon and (impurit$3 or dop$3 or implant$3 or ion$1) and (through-hole or opening or hole or passage$3 or slot)).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 17:20
—	10	(("6113222") or ("6128052") or ("6139761") or ("6143190") or ("6305080")).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 17:02

-	248	(216/17 or 216/39 or 216/41 or 216/46 or 438/700 or 438/705 or 438/740) and (etch$3 and silicon and (impurit$3 or dop$3 or implant$3 or ion$1) and (through-hole or opening or hole or passage$3 or slot)).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 17:13
-	37	((ink$1jet or printhead) and etch$3 and silicon and (impurit$3 or dop$3 or implant$3 or ion$1) and (channel)).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 17:28
-	8	("4106976" | "4169008" | "4417946" | "4455192" | "4589952" | "4639748" | "4733823" | "4864329").PN.	USPAT	2004/10/05 17:21
-	30	5141596.URPN.	USPAT	2004/10/05 17:23
-	4	(("6554403") or ("20030202049")).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/05 17:28
-	2	"11204751"	JPO; DERWENT	2004/10/08 17:40
-	3	"2000021850"	JPO; DERWENT	2004/10/08 17:40